

2SK1517, 2SK1518

Silicon N Channel MOS FET

REJ03G0947-0200
(Previous: ADE-208-1287)
Rev.2.00
Sep 07, 2005

Application

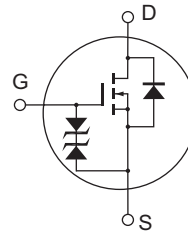
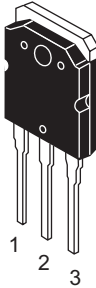
High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- Built-in fast recovery diode ($t_{rr} = 120$ ns)
- Suitable for motor control, switching regulator, DC-DC converter

Outline

RENESAS Package code: PRSS0004ZE-A
(Package name: TO-3P)



1. Gate
2. Drain
(Flange)
3. Source

Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	2SK1517	450	V
	2SK1518	500	
Gate to source voltage	V _{GSS}	±30	V
Drain current	I _D	20	A
Drain peak current	I _{D(pulse)} ^{*1}	80	A
Body to drain diode reverse drain current	I _{DR}	20	A
Channel dissipation	P _{ch} ^{*2}	120	W
Channel temperature	T _{ch}	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

Notes: 1. PW ≤ 10 μs, duty cycle ≤ 1%

2. Value at T_C = 25°C

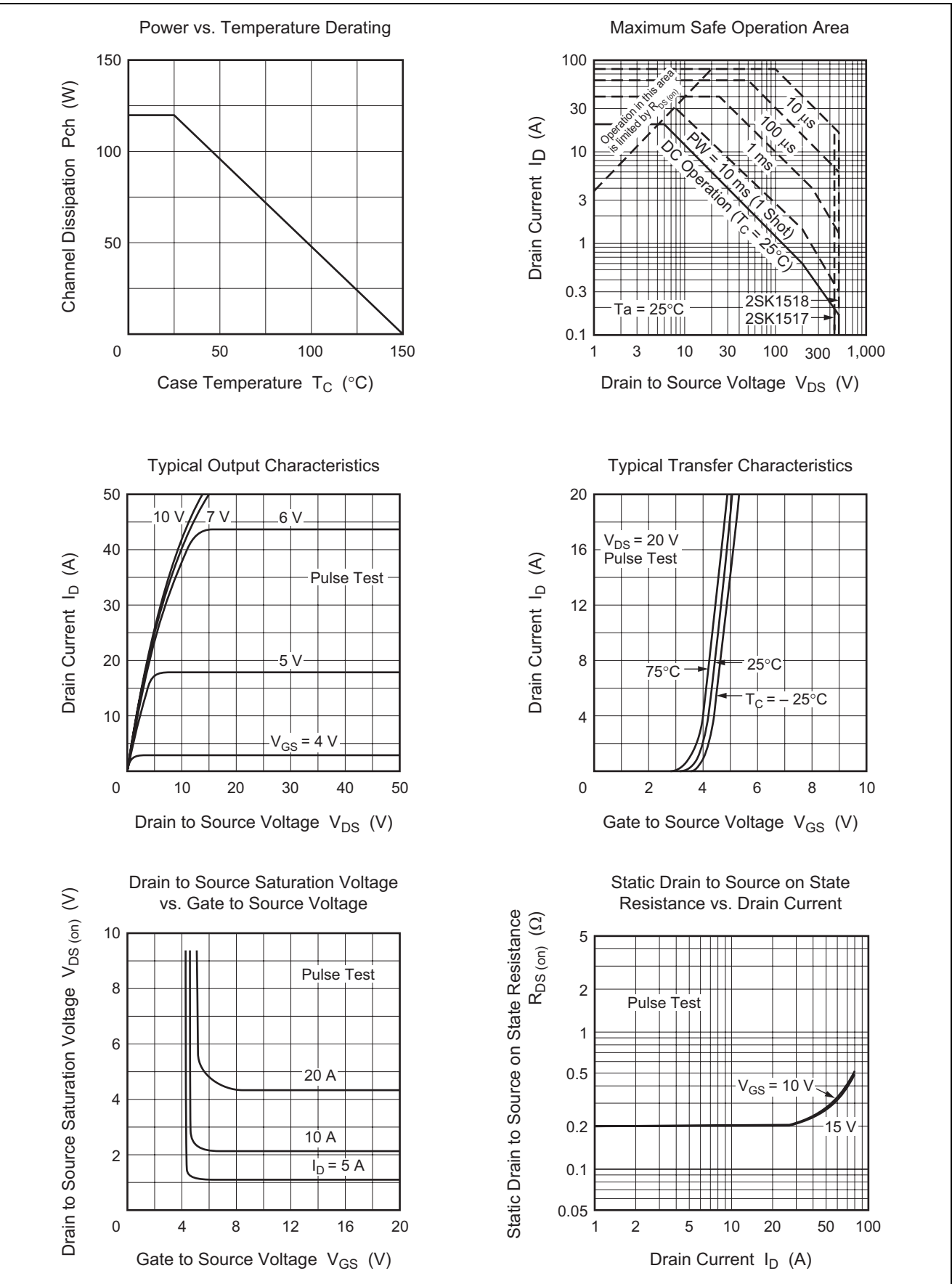
Electrical Characteristics

(Ta = 25°C)

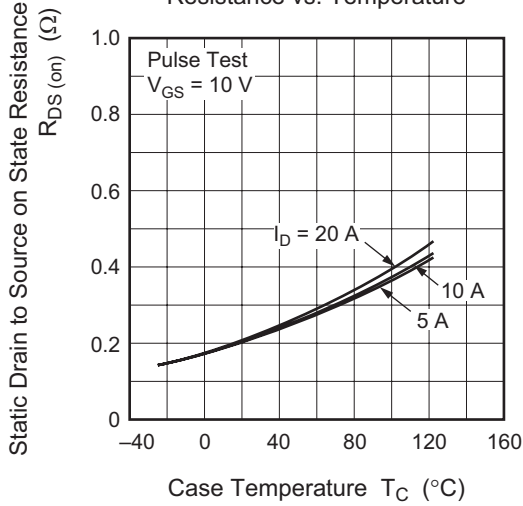
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	2SK1517	450	—	—	V	I _D = 10 mA, V _{GS} = 0
	2SK1518	500				
Gate to source breakdown voltage	V _{(BR)GSS}	±30	—	—	V	I _G = ±100 μA, V _{DS} = 0
Gate to source leak current	I _{GSS}	—	—	±10	μA	V _{GS} = ±25 V, V _{DS} = 0
Zero gate voltage drain current	2SK1517	—	—	250	μA	V _{DS} = 360 V, V _{GS} = 0
	2SK1518					V _{DS} = 400 V, V _{GS} = 0
Gate to source cutoff voltage	V _{GS(off)}	2.0	—	3.0	V	I _D = 1 mA, V _{DS} = 10 V
Static drain to source on state resistance	2SK1517	—	0.20	0.25	Ω	I _D = 10 A, V _{GS} = 10 V ^{*3}
	2SK1518		—	0.22		
Forward transfer admittance	y _{fs}	10	16	—	S	I _D = 10 A, V _{DS} = 10 V ^{*3}
Input capacitance	C _{iss}	—	3050	—	pF	V _{DS} = 10 V, V _{GS} = 0,
Output capacitance	C _{oss}	—	940	—	pF	f = 1 MHz
Reverse transfer capacitance	C _{rss}	—	140	—	pF	
Turn-on delay time	t _{d(on)}	—	35	—	ns	I _D = 10 A, V _{GS} = 10 V, R _L = 3 Ω
Rise time	t _r	—	130	—	ns	
Turn-off delay time	t _{d(off)}	—	240	—	ns	
Fall time	t _f	—	105	—	ns	
Body to drain diode forward voltage	V _{DF}	—	1.0	—	V	I _F = 20 A, V _{GS} = 0
Body to drain diode reverse recovery time	t _{rr}	—	120	—	ns	I _F = 20 A, V _{GS} = 0, di _F /dt = 100 A/μs

Note: 3. Pulse test

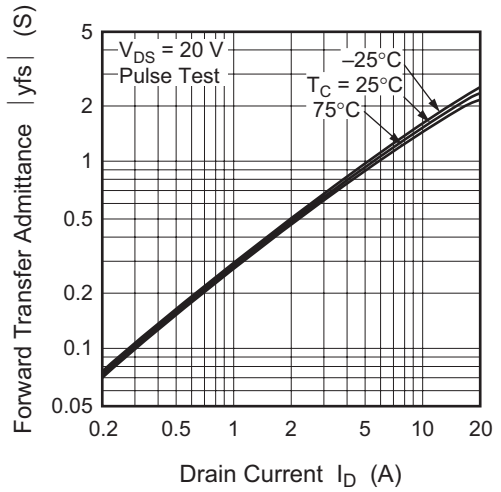
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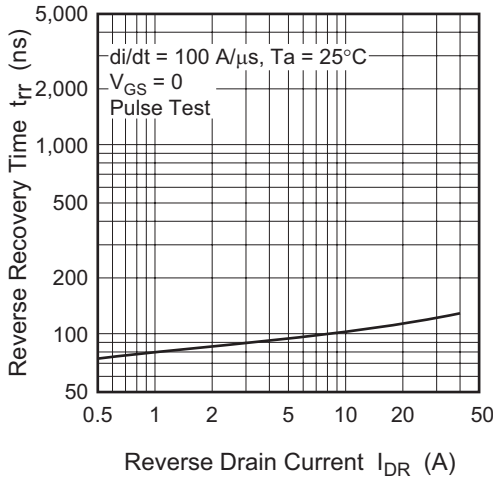
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 Static Drain to Source on State Resistance vs. Temperature



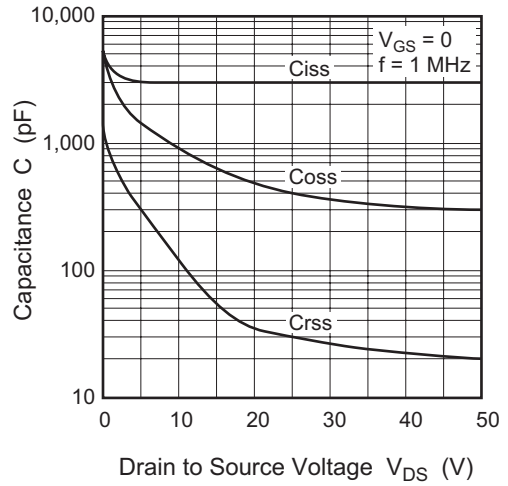
Forward Transfer Admittance vs. Drain Current



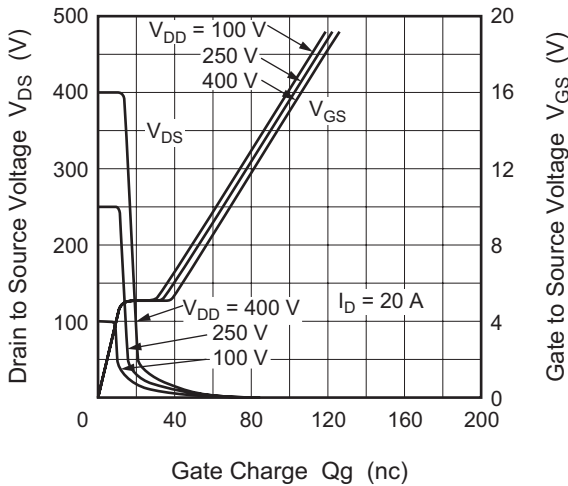
Body to Drain Diode Reverse Recovery Time



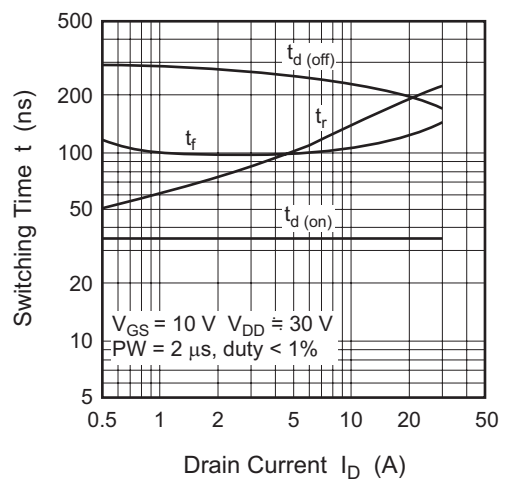
Typical Capacitance vs. Drain to Source Voltage



Dynamic Input Characteristics

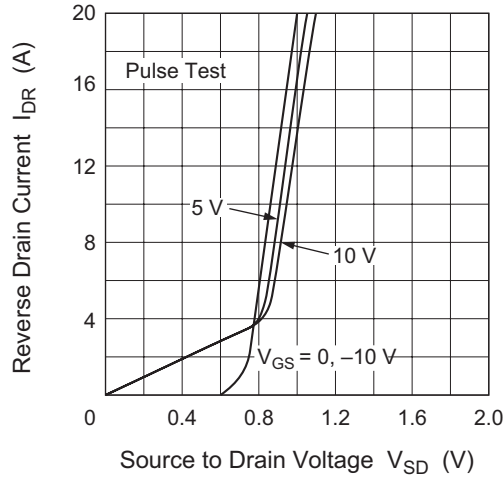


Switching Characteristics

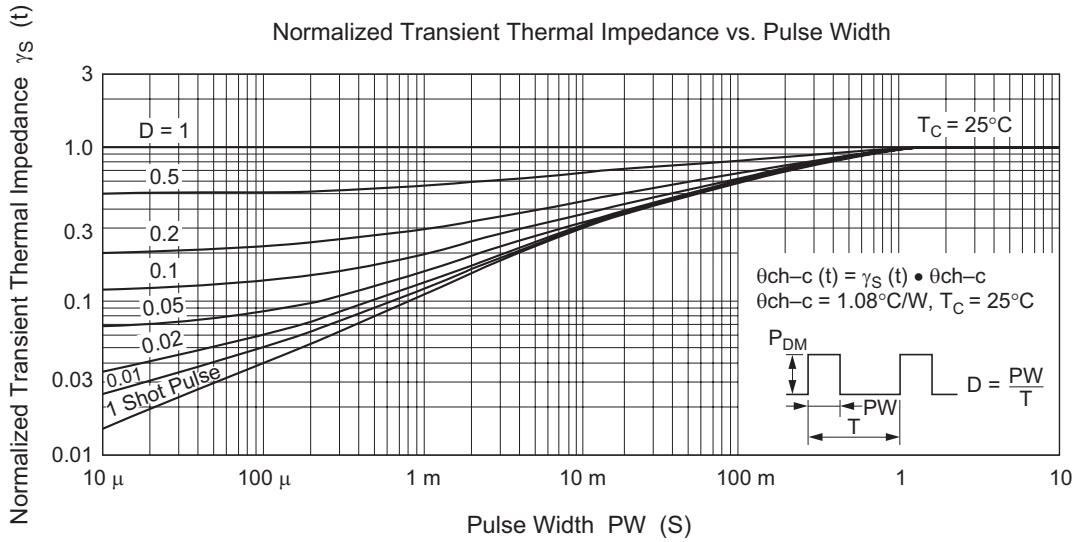


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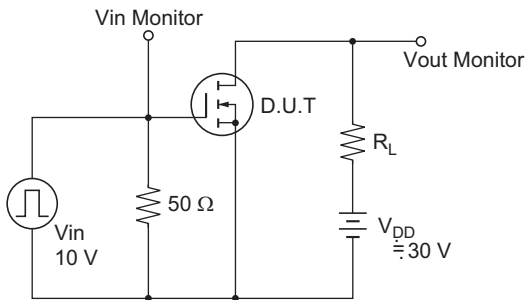
Reverse Drain Current vs. Source to Drain Voltage



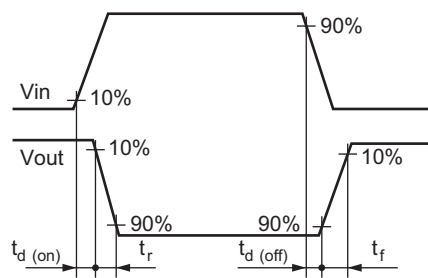
Normalized Transient Thermal Impedance vs. Pulse Width



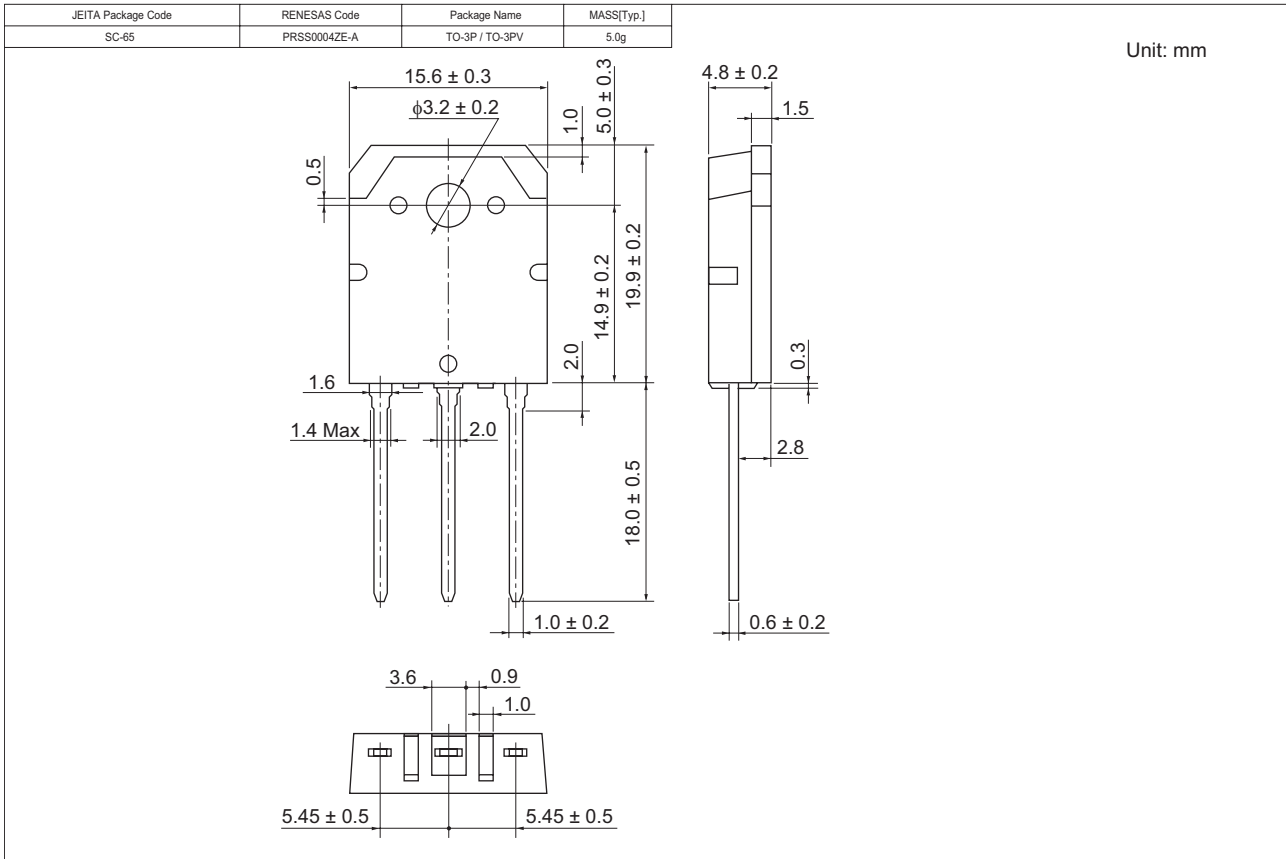
Switching Time Test Circuit



Waveforms



Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SK1517-E	360 pcs	Box (Tube)
2SK1518-E	360 pcs	Box (Tube)

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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